





**GRF2040** 

RELEASE Ø DATA SHEET

# **Broadband Linear Gain Block with Bypass** 0.05 to 5 GHz

### **FEATURES**

- Flexible Bias
- $\bullet$  Internally Matched to 50  $\Omega$
- Process: GaAs pHEMT
- Compact 1.5 x 1.5 mm DFN-6 Package
- RoHS Compliant

### Gain Mode Reference: 5 V / 90 mA / 2 GHz

Gain: 10.2 dBOP1dB: 20.9 dBmOIP3: 35.3 dBm

• Evaluation Board Noise Figure: 3.4 dB

### Bypass Mode Reference: 5 V / 0.5 mA / 2 GHz

• Gain: -1.6 dB

• OP1dB: 25.2 dBm

OIP3: 43.4 dBm

### **APPLICATIONS**

- Systems Requiring Flat Gain
- Linear Driver Amplifier
- Small Cells and Cellular Repeaters
- IF Amplifier



### **M** DESCRIPTION

The GRF2040 is a broadband gain block with exceptional gain flatness for small cell, wireless infrastructure and other high-performance applications. It exhibits outstanding broadband noise figure (NF) and linearity from 400 to 4000 MHz with a single match and can be optimized for applications from 50 MHz to 5 GHz.

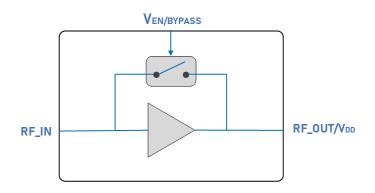
The device can be operated from a supply voltage of 2.7 to 8 V with a selectable  $I_{DDQ}$  range of 15 to 90 mA for optimal efficiency and linearity.

The GRF2040 is internally matched to 50  $\Omega$  at the input and output ports requiring only external DC blocks and a bias choke on the output.

Please consult with the GRF applications engineering team for custom tuning/evaluation board data and device S-parameters.

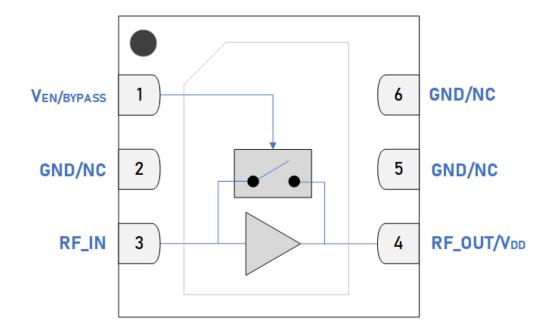
Additional tunes can be found on the GRF2040 "Custom Tunes" product page: GRF2040 Custom Tunes

## **BLOCK DIAGRAM**









Pin Out (Top View)





# **Pin Assignments**

Pin	Name	Description	Note
1	Venable	Enable Voltage Input	$V_{\rm ENABLE}$ and series resistor set $I_{\rm DDQ}$ . $V_{\rm ENABLE} \leq 0.2$ volts disables device. On-die pull-down resistor will turn the device off if this node is allowed to float. Note: Pin 1 voltage should not exceed 3.0 V due to excessive resulting $I_{\rm ENABLE}$ .
2, 5, 6	GND/NC	Ground or No Connect	No internal connection to die.
3	RF_IN	RF Input	Internally matched to 50 $\Omega$ . An external DC blocking capacitor must be used.
4	RF_OUT/V <sub>DD</sub>	RF Output	Internally matched to 50 $\Omega$ . $V_{DD}$ must be applied through an RF choke to this pin.
PKG BASE	GND	Ground	Provides DC and RF ground for LNA, as well as thermal heat sink. Recommend multiple 8 mil vias beneath the package for optimal RF and thermal performance. Refer to evaluation board top layer graphic on schematic page.



RELEASE Ø DATA SHEET

# **Absolute Ratings**

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	V <sub>DD</sub>	0	9	V
RF Input Power: Load VSWR < 2:1, V <sub>DD</sub> ≤ 8 V	P <sub>IN MAX</sub>		27	dBm
Operating Temperature (Package Base)	T <sub>PKG BASE</sub>	-40	105	°C
Maximum Channel Temperature (MTTF > 10 <sup>6</sup> Hours)	T <sub>MAX</sub>		170	°C
Maximum Dissipated Power	P <sub>DISS</sub> MAX		1	W

### **Electrostatic Discharge**

Human Body Model	НВМ	200		V
------------------	-----	-----	--	---

## Storage

Storage Temperature	T <sub>STG</sub>	-65	150	°C
Moisture Sensitivity Level	MSL		1	



**Caution! ESD Sensitive Device.** 

**Exceeding Absolute Maximum Rating conditions may cause permanent damage.** 

Note: For additional information, please refer to Manufacturing Note MN-001 - Packaging and Manufacturing Information.



All Guerrilla RF products are provided in RoHS compliant lead (Pb)-free packaging. For additional information, please refer to the Certificate of RoHS Compliance.





# **Recommended Operating Conditions**

Parameter	Specification Symbol			on	Unit	Condition
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition
Supply Voltage	V <sub>DD</sub>	2.7	5	9	V	
Operating Temperature Range	T <sub>PKG BASE</sub>	-40		105	°C	
RF Frequency Range	F <sub>RF</sub>	0.05	2	5	GHz	Typical Application Schematic with external matching components (notes 1 & 2).
RF_IN Port Impedance	Z <sub>RFIN</sub>		50		Ω	Single Ended.
RF_OUT Port Impedance	Z <sub>RFOUT</sub>		50		Ω	Single Ended.

**Note 1:** Operation outside of this range is supported by using different custom tunes. Examples of other optimized tunes can be found here: <u>GRF2040 Custom Tunes</u>

**Note 2:** Contact the GRF applications team for guidance on optimizing the tuning of the device for alternative bands.



RELEASE Ø DATA SHEET

# **Nominal Operating Parameters - General**

Parameter	Specification Symbol			n	Unit	Condition	
raiailletei	Symbol	Min.	Тур.	Max.	Offic	Condition	
Switching Rise Time	T <sub>RISE</sub>		80		ns	Disabled Mode to Gain Mode. Pout = 0 dBm (note 3).	
Switching Fall Time	T <sub>FALL</sub>		30		ns	Gain Mode to Disabled Mode. Pout = 0 dBm (note 4).	
Supply Current	I <sub>DD</sub>		90		mA	$V_{DD} = 5 \text{ V}, V_{ENABLE} = 5 \text{ V}.$	
Enable Current	I <sub>ENABLE</sub>		5		mA	V <sub>DD</sub> = 5 V, V <sub>ENABLE</sub> = 5 V.	

#### **Thermal Data**

Thermal Resistance (Infrared Scan)	Θлс	75		°C/W	On standard evaluation board (note 5).
------------------------------------	-----	----	--	------	--

Note 3: Switching Time: 50% of  $V_{\text{ENABLE}}$  to 90% of  $P_{\text{OUT}}$ .

Note 4: Switching Time: 50% of V<sub>ENABLE</sub> to 10% of P<sub>OUT</sub>.

**Note 5:** MTTF >  $10^6$  hours for  $T_j \le 170$  °C.





# **Nominal Operating Parameters - RF**

The following conditions apply unless noted otherwise; Typical Application Schematic,  $V_{DD} = 5 \text{ V}$ ,  $F_{TEST} = 2 \text{ GHz}$ , 50  $\Omega$  system impedance,  $T_{PKG BASE} = 25 ^{\circ}\text{C}$ . Evaluation board losses are included within the specifications.

### **Gain Mode**

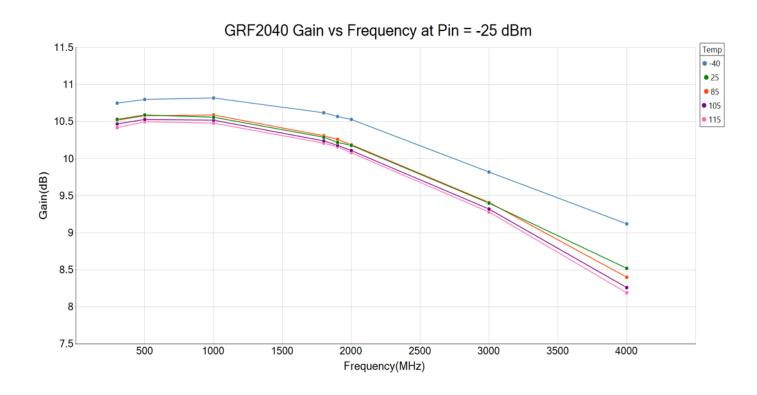
Parameter	Specification Symbol		Unit	Condition		
		Min.	Тур.	Max.		
Supply Current	I <sub>DD</sub>		90		mA	$V_{DD} = 5 \text{ V}, V_{ENABLE} = 5 \text{ V}.$
Gain	S21		10.2		dB	
Noise Figure	NF		3.4		dB	On standard evaluation board.
Output 3rd Order Intercept Point	OIP3		35.3		dBm	2 dBm P <sub>OUT</sub> per tone at 2 MHz spacing (2000 and 2002 MHz).
Output 1 dB Compression Power	OP1dB		20.9		dBm	

## **Bypass Mode**

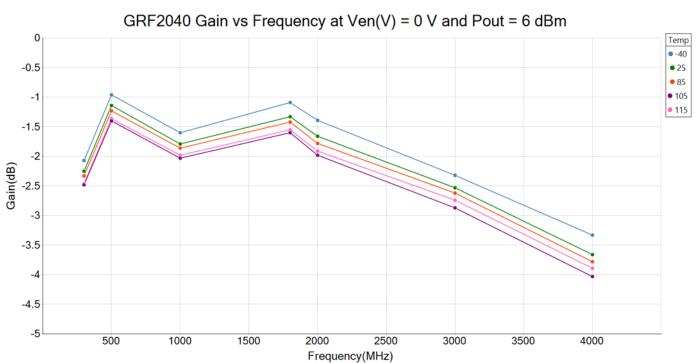
Parameter	Symbol	Specification			Unit	Condition
		Min.	Тур.	Max.		
Supply Current	I <sub>DD</sub>		0.5		mA	$V_{DD} = 5 \text{ V}, V_{ENABLE} = 0 \text{ V}.$
Gain	S21		-1.6		dB	
Output 3rd Order Intercept Point	OIP3		43.4		dBm	2 dBm P <sub>OUT</sub> per tone at 2 MHz spacing (2000 and 2002 MHz).
Output 1 dB Compression Power	OP1dB		25.2		dBm	



# **GRF2040 Typical Operating Curves: 0.4 to 4 GHz Tune**



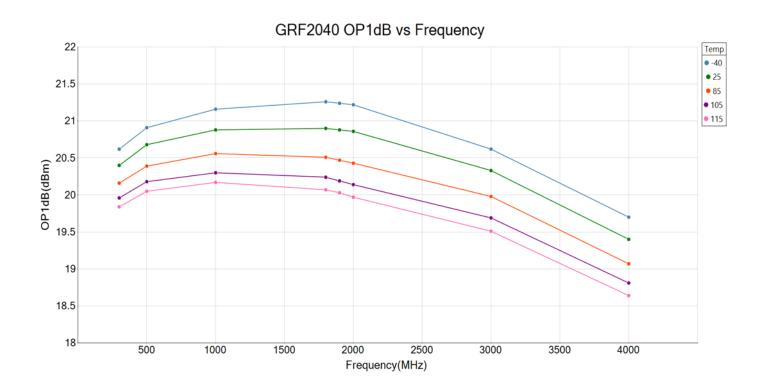
## **Bypass Mode Gain**



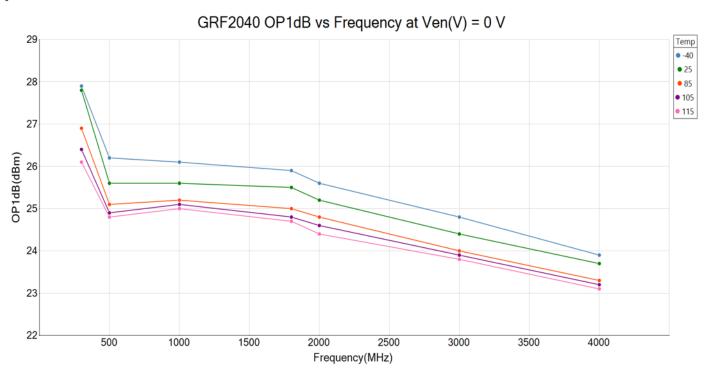




# **GRF2040 Typical Operating Curves: 0.4 to 4 GHz Tune**



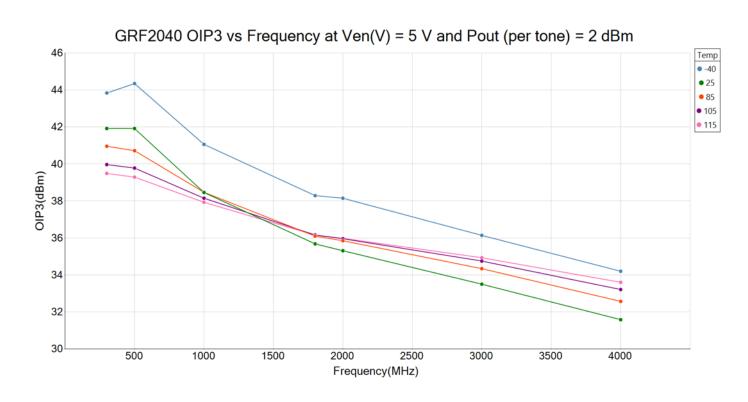
## **Bypass Mode OP1dB**



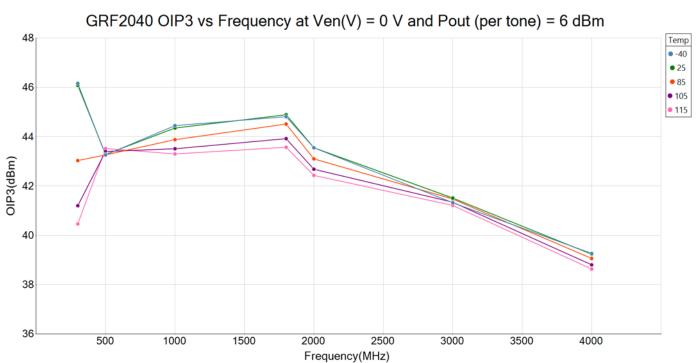




# **GRF2040 Typical Operating Curves: 0.4 to 4 GHz Tune**

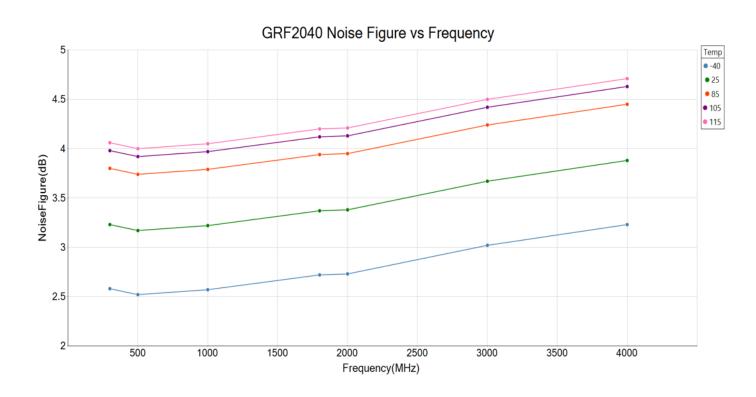


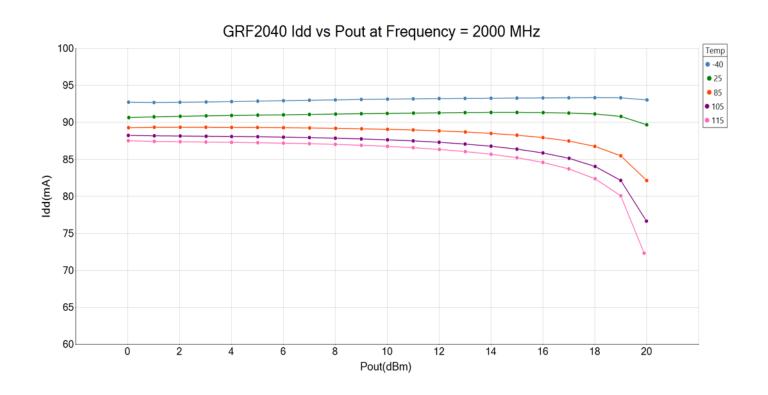
# **Bypass Mode OIP3**





# **GRF2040 Typical Operating Curves: 0.4 to 4 GHz Tune**

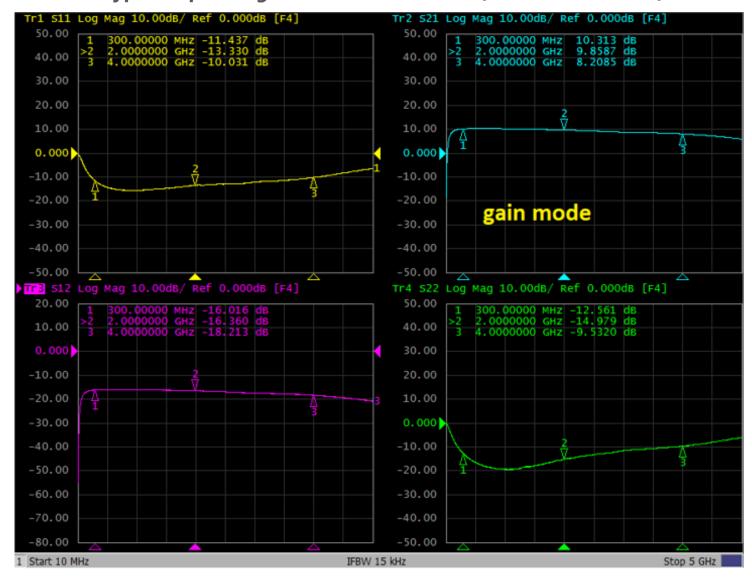






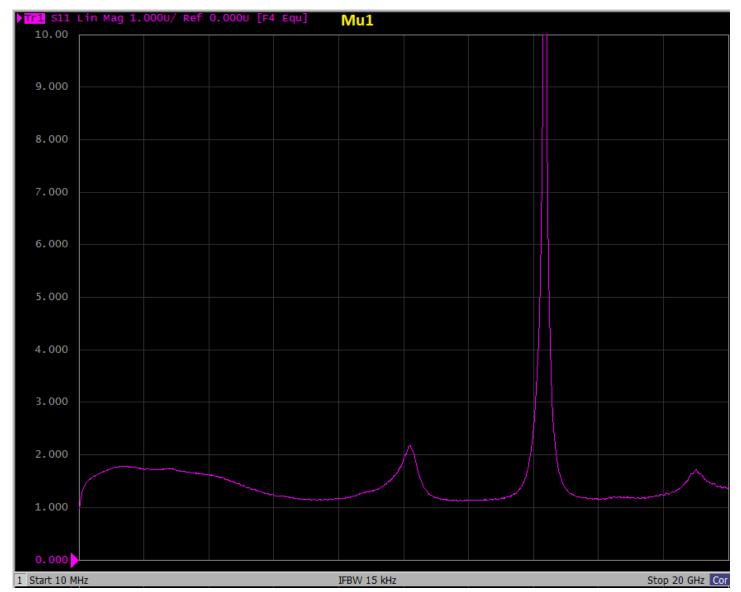


## **GRF2040 Typical Operating Curves: S-Parameters (300 MHz to 4 GHz)**





# **GRF2040 Typical Operating Curves: Stability Mu Factor (10 MHz to 20 GHz)**

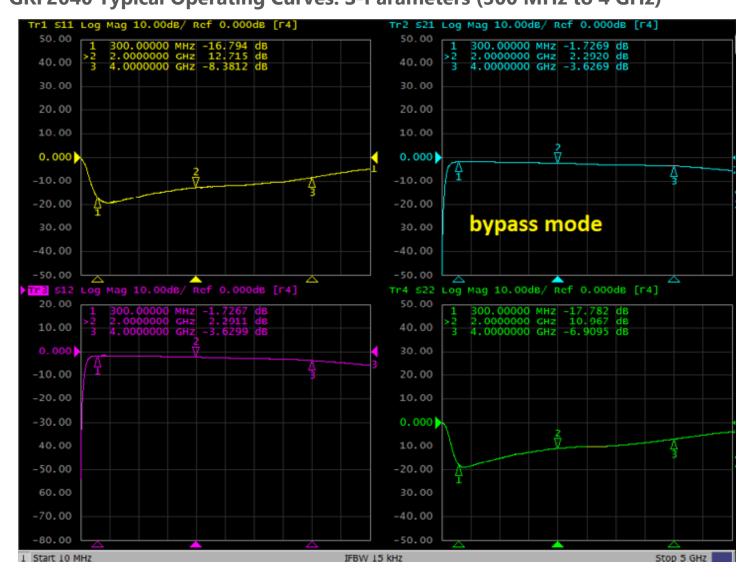


Note: Mu Factor ≥ 1.0 implies unconditional stability.

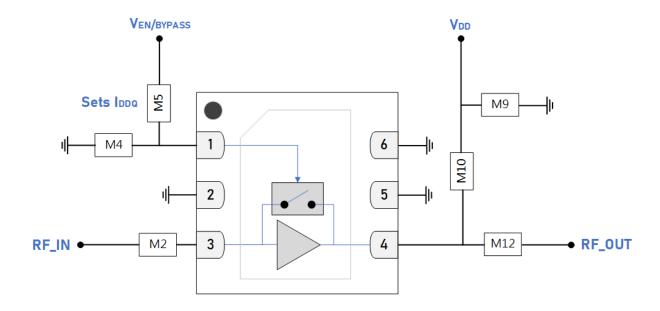




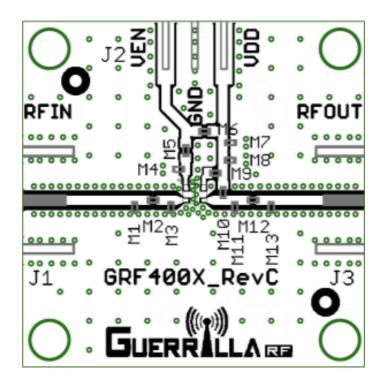
# **GRF2040 Typical Operating Curves: S-Parameters (300 MHz to 4 GHz)**







## **GRF2040 Standard Evaluation Board Schematic**



**GRF2040 Evaluation Board Assembly Diagram** 



RELEASE Ø DATA SHEET

# **GRF2040 Evaluation Board Assembly Diagram Reference (0.4 to 4 GHz Tune)**

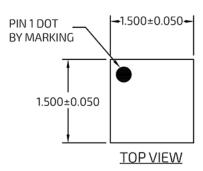
Component	Туре	Manufacturer	Family	Value	Package Size	Substitution
M2	Capacitor	Murata	GRM	100 pF	0402	ok
M4	Capacitor	Murata	GRM	100 pF	0402	ok
M5 (sets I <sub>DDQ</sub> )	Resistor	Various	5%	500 Ω	0402	ok
M9	Capacitor	Murata	GRM	0.1 μF	0402	ok
M10	Inductor	Murata	LQG	47 nH	0402	ok
M12	Capacitor	Murata	GRM	100 pF	0402	ok
Evaluation Board	GRF400X_ RevC					

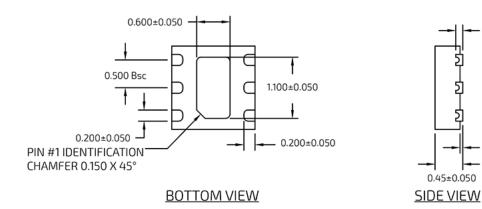
0.127 Ref.

0.000-0.050



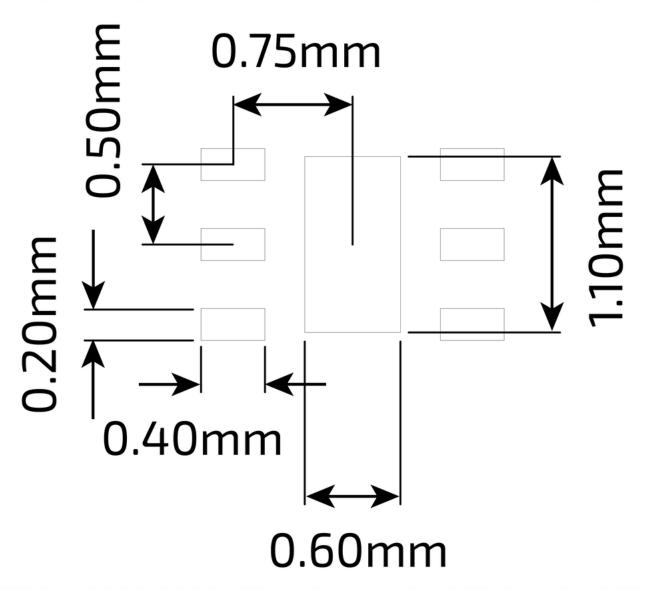
**GRF2040** Broadband Linear Gain Block with Bypass 0.05 to 5 GHz





**DFN 6 1.5x1.5mm Package Dimensions** 





**DFN 6 1.5x1.5mm Suggested PCB Footprint (Top View)** 



### **Package Marking Diagram**

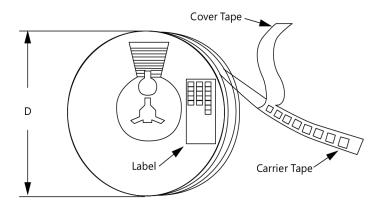


Line 1: "Y" = YEAR (single digit). "WW" = WORK WEEK the Device was assembled.

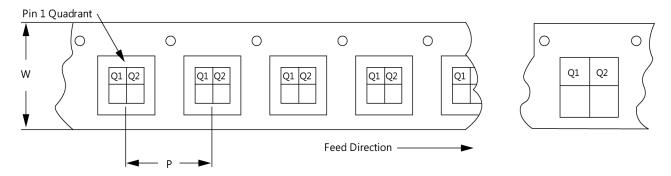
Line 2: "XXXX" = Device Part Number.

### **Tape and Reel Information**

Guerrilla RF's tape and reel specification complies with Electronics Industries Association (EIA) standards for "Embossed Carrier Tape of Surface Mount Components for Automatic Handling" (reference EIA-481). Devices are loaded with pins down into the carrier pocket with protective cover tape and reeled onto a plastic reel. Each reel is packaged in a cardboard box. There are product labels on the reel, the protective ESD bag, and the outside surface of the box. For the latest reel specifications and package information (including units/reel), please visit Package Manufacturing Information | Guerrilla RF (querrilla-rf.com).



Tape and Reel Packaging with Reel Diameter Noted (D)



Carrier Tape Width (W), Pitch (P), Feed Direction and Pin 1 Quadrant Information



RELEASE Ø DATA SHEET

## **Revision History**

Revision Date	Description of Change
October 12, 2023	Preliminary Data Sheet.
May 31, 2024	Updated HBM specification.
September 9, 2024	Release $\varnothing$ Data Sheet. Updated RF specifications and plots. Changed HBM from 125 to 200 volts.



RELEASE Ø DATA SHEET

#### **Data Sheet Classifications**

Data Sheet Status	Notes
Advance	S-parameter and NF data based on EM simulations for the fully packaged device using foundry-supplied transistor S-parameters. Linearity estimates based on device size, bias condition and experience with related devices.
Preliminary	All data based on evaluation board measurements taken within the Guerrilla RF Applications Lab. Any MIN/MAX limits represented within the data sheet are based solely on <i>estimated</i> part-to-part variations and process spreads. All parametric values are subject to change pending the collection of additional data.
Release Ø	All data based on measurements taken with <i>production-released</i> material. TYP values are based on a combination of ATE and bench-level measurements, with MIN/MAX limits defined using <i>modelled estimates</i> that account for part-to-part variations and expected process spreads. Although unlikely, future refinements to the TYP/MIN/MAX values may be in order as multiple lots are processed through the factory.
Release A-Z	All data based on measurements taken with production-released material derived from multiple lots which have been fabricated over an extended period of time. MIN/MAX limits may be refined over previous releases as more statistically significant data is collected to account for process spreads.

Information in this data sheet is specific to the Guerrilla RF, Inc. ("Guerrilla RF") product identified.

This data sheet, including the information contained in it, is provided by Guerrilla RF as a service to its customers and may be used for informational purposes only by the customer. Guerrilla RF assumes no responsibility for errors or omissions on this data sheet or the information contained herein. Information provided is believed to be accurate and reliable, however, no responsibility is assumed by Guerrilla RF for its use, nor for any infringement of patents, or other rights of third parties, resulting from its use. Guerrilla RF assumes no liability for any data sheet, data sheet information, materials, products, product information, or other information provided hereunder, including the sale, distribution, reproduction or use of Guerrilla RF products, information or materials.

No license, whether express, implied, by estoppel, by implication or otherwise granted by this data sheet for any intellectual property of Guerrilla RF, or any third party, including without limitation, patents, patent rights, copyrights, trademarks, and trade secrets. All rights are reserved by Guerrilla RF.

All information herein, products, product information, data sheets, and data sheet information are subject to change and availability without notice. Guerrilla RF reserves the right to change component circuitry, recommended application circuitry and specifications at any time without prior notice. Guerrilla RF may further change its data sheet, product information, documentation, products, services, specifications or product descriptions at any time, without notice. Guerrilla RF makes no commitment to update any materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

GUERRILLA RF INFORMATION, PRODUCTS, PRODUCT INFORMATION, DATA SHEETS AND DATA SHEET INFORMATION ARE PROVIDED "AS IS" AND WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. GUERRILLA RF DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. GUERRILLA RF SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Customers are solely responsible for their use of Guerrilla RF products in the Customer's products and applications or in ways which deviate from Guerrilla RF's published specifications, either intentionally or as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Guerrilla RF assumes no liability or responsibility for applications assistance, customer product design, or damage to any equipment resulting from the use of Guerrilla RF products outside of stated published specifications or parameters.